

# DHI-DDR-C300

# Memory Module





- $\cdot$  Uses featured DRAM chip to provide great performance and high-speed data transmission.
- · Curved gold finger to ensure stable installation and signal transmission.
- · Reliable quality and lifetime warranty.
- $\cdot$  Highly compatible; supports mainstream platforms such as Intel and AMD; plug-and-play.

### **System Overview**

The C300 series memory modules are DDR4 DRAM products with SODIMM and UDIMM models. With operating frequency of 2666 MHZ, they not only provide faster data exchange speed, but also greatly improve the overall performance of the system.

#### **Functions**

### **Featured DRAM Chip and Great Performance**

Uses high-quality DRAM chip to provide great performance and long service life.

#### **Meet Various Needs**

Meets the needs of consumers for PC memory replacement and device upgrade to provide fast experience.

### **Compatible with Various Products**

Compatible with Intel and AMD platforms; passes tests with various motherboards of well-known brands; highly compatible and stable.

# Scene

The C300 series is designed to meet the needs of consumers for PC memory replacement and device upgrade. The operating frequency is as high as 2666 MHz to support multi-thread and multi-task operation of the system. They can be widely used in laptops, desktops, all-in-one computers, and more.

# **Technical Specification**

#### Technical

Product Model	DHI-DDR- C300S4G26	DHI-DDR- C300S8G26	DHI-DDR- C300S16G26	DHI-DDR- C300S32G26
Capacity	4 GB	8 GB	16 GB	32 GB
Туре	SODIMM			
Applicable Model	DDR4 laptop			
Voltage	1.2 V			
CAS Latency	CL19			
Operating Frequency	2666 MHz			
Number of Pins	260			
Operating Temperature	0 °C to +70 °C (+32 °F to 158 °F)			
Storage Temperature	20 °C to +85 °C (-4 °F to +185 °F)			
Operating Humidity	25%–85% (non-condensing)			
Warranty	Lifetime			
Product Dimensions	69.6 mm × 30 mm × 3.58 mm (2.74" × 1.18" × 0.14")①			
Packaging Dimensions	165 mm × 51 mm × 16.5 mm (6.50" × 2.01" × 0.65")			
Net Weight	8.5 g (0.02 lb)			
Gross Weight	36 g (0.08 lb)			



Reference Information	Note: ①The thickness is calculated at the thickest point.  1. For different batches of products, memory chips of different brands and models will be used. All chips have been strictly tested to ensure quality. Chip brand and testing results of third-party softwares cannot be the basis for whether the product is genuine.  2. For products with the same capacity, there are 8 chips and 16 chips, which will be shipped randomly according to the inventory.  3. For memory modules of the same generation, the operating frequency is backward compatible. For example, the frequency of DDR4 includes 2400, 2666, 3000 and more. The memory module with the frequency of 3000 can be used in motherboards supporting 2666 or 2400 with lower frequency.

# **Technical Specification**

## Technical

Product Model	DHI-DDR- C300S4G32	DHI-DDR- C300S8G32	DHI-DDR- C300S16G32	DHI-DDR- C300S32G32
Capacity	4 GB	8 GB	16 GB	32 GB
Туре	SODIMM			
Applicable Model	DDR4 laptop			
Voltage	1.2 V			
CAS Latency	CL22			
Operating Frequency	3200 MHz			
Number of Pins	260			
Operating Temperature	0 °C to +70 °C (+32 °F to 158 °F)			
Storage Temperature	20 °C to +85 °C (-4 °F to +185 °F)			
Operating Humidity	25%–85% (non-condensing)			
Warranty	Lifetime			
Product Dimensions	69.6 mm × 30 mm × 3.58 mm (2.74" × 1.18" × 0.14") $\bigcirc$			
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# **Technical Specification**

## Technical

Product Model  DHI-DDR-C300U8G26 C300U8G26 C300U1GG26 Capacity  4 GB  8 GB  16 GB  32 GB  Type  UDIMM  Applicable Model  DDR4 desktop  Voltage  1.2 V  CAS Latency  CL19  Operating Frequency 2666 MHz  Number of Pins  288  Operating Temperature 20 °C to +85 °C (-4 °F to +185 °F)  Storage Temperature 25%-85% (non-condensing)  Warranty  Lifetime  Product Dimensions 69.6 mm × 30 mm × 3.58 mm (2.74" × 1.18" × 0.14") ①  Packaging Dimensions 165 mm × 51 mm × 16.5 mm (6.50" × 2.01" × 0.65")  Net Weight  44 g (0.10 lb)  Note: ① The thickness is calculated at the thickest point. 1. For different bardes of products, memory chips of different brands and models will be used. All chips have been strictly tested to ensure quality. Chip brand and testing results of third-party softwares cannot be the basis for whether the product is genuine. 2. For products with the same capacity, there are 8 chips and 16 chips, which will be shipped randomly according to the inventory. 3. For memory modules of the same generation, the operating frequency is DDR4 includes 2400, 2666, 3000 and more. The memory module with the frequency of 3000 can be used in motherboards supporting 2666 or 2400 with lower frequency.	recnnicai				
Type  UDIMM  Applicable Model  DDR4 desktop  Voltage  1.2 V  CAS Latency  CL19  Operating Frequency  2666 MHz  Number of Pins  288  Operating Temperature  0 °C to +70 °C (+32 °F to 158 °F)  Storage Temperature  20 °C to +85 °C (-4 °F to +185 °F)  Operating Humidity  25%—85% (non-condensing)  Warranty  Lifetime  Product Dimensions  69.6 mm × 30 mm × 3.58 mm (2.74" × 1.18" × 0.14") ①  Packaging Dimensions  165 mm × 51 mm × 16.5 mm (6.50" × 2.01" × 0.65")  Net Weight  16 g (0.04 lb)  Gross Weight  A4 g (0.10 lb)  Note: ①The thickness is calculated at the thickest point.  1. For different barches of products, memory chips of different brands and models will be used. All chips have been strictly tested to ensure quality. Chip brand and testing results of third-party softwares cannot be the basis for whether the product is genuine.  2. For products with the same capacity, there are 8 chips and 16 chips, which will be shipped randomly according to the inventory.  3. For memory modules of the same generation, the operating frequency of DDR4 includes 2400, 2666, 3000 and more. The memory module with the frequency of 3000 can be used in motherboards supporting 2666 or 2400 with lower	Product Model				
Applicable Model  DDR4 desktop  Voltage  1.2 V  CAS Latency  CDL19  Operating Frequency  2666 MHz  Number of Pins  288  Operating Temperature  0 °C to +70 °C (+32 °F to 158 °F)  Storage Temperature  20 °C to +85 °C (-4 °F to +185 °F)  Operating Humidity  Lifetime  Product Dimensions  69.6 mm × 30 mm × 3.58 mm (2.74" × 1.18" × 0.14")①  Packaging Dimensions  165 mm × 51 mm × 16.5 mm (6.50" × 2.01" × 0.65")  Net Weight  16 g (0.04 lb)  Gross Weight  44 g (0.10 lb)  Note: ① The thickness is calculated at the thickest point. 1. For different batches of products, memory chips of different brands and models will be used. All chips have been strictly tested to ensure quality. Chip brand and testing results of third-party softwares cannot be the basis for whether the product is genuine. 2. For products with the same capacity, there are 8 chips and 16 chips, which will be shipped randomly according to the inventory. 3. For memory modules of the same generation, the operating frequency of DDR4 includes 2400, 2666, 3000 and more. The memory module with the frequency of 3000 can be used in motherboards supporting 2666 or 2400 with lower	Capacity	4 GB	8 GB	16 GB	32 GB
CAS Latency CL19 Operating Frequency 2666 MHz Number of Pins 288 Operating Temperature 0 °C to +70 °C (+32 °F to 158 °F) Storage Temperature 20 °C to +85 °C (-4 °F to +185 °F) Operating Humidity 25%-85% (non-condensing) Warranty Lifetime Product Dimensions 69.6 mm × 30 mm × 3.58 mm (2.74" × 1.18" × 0.14")(1) Packaging Dimensions 165 mm × 51 mm × 16.5 mm (6.50" × 2.01" × 0.65") Net Weight 16 g (0.04 lb) Gross Weight 44 g (0.10 lb) Note: (1) The thickness is calculated at the thickest point. 1. For different batches of products, memory chips of different brands and models will be used. All chips have been strictly tested to ensure quality. Chip brand and testing results of third-party softwares cannot be the basis for whether the product is genuine. 2. For products with the same capacity, there are 8 chips and 16 chips, which will be shipped randomly according to the inventory. 3. For memory modules of the same generation, the operating frequency is backward compatible. For example, the frequency of DDR4 includes 2400, 2666, 3000 and more. The memory module with the frequency of 3000 can be used in motherboards supporting 2666 or 2400 with lower	Туре	UDIMM			
CAS Latency  CL19  Operating Frequency  2666 MHz  Number of Pins  288  Operating Temperature  0 °C to +70 °C (+32 °F to 158 °F)  Storage Temperature  20 °C to +85 °C (-4 °F to +185 °F)  Operating Humidity  25%—85% (non-condensing)  Warranty  Lifetime  Product Dimensions  69.6 mm × 30 mm × 3.58 mm (2.74" × 1.18" × 0.14")(1)  Packaging Dimensions  165 mm × 51 mm × 16.5 mm (6.50" × 2.01" × 0.65")  Net Weight  16 g (0.04 lb)  Gross Weight  44 g (0.10 lb)  Note: (1) The thickness is calculated at the thickest point.  1. For different batches of products, memory chips of different brands and models will be used. All chips have been strictly tested to ensure quality. Chip brand and testing results of third-party softwares cannot be the basis for whether the product is genuine.  2. For products with the same capacity, there are 8 chips and 16 chips, which will be shipped randomly according to the inventory.  3. For memory modules of the same generation, the operating frequency is backward compatible. For example, the frequency of DDR4 includes 2400, 2666, 3000 and more. The memory module with the frequency of 3000 can be used in motherboards supporting 2666 or 2400 with lower	Applicable Model	DDR4 desktop			
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# **Technical Specification**

## Technical

Product Model	DHI-DDR- C300U4G32	DHI-DDR- C300U8G32	DHI-DDR- C300U16G32	DHI-DDR- C300U32G32
Capacity	4 GB	8 GB	16 GB	32 GB
Туре	UDIMM	UDIMM		
Applicable Model	DDR4 desktop			
Voltage	1.2 V			
CAS Latency	CL22			
Operating Frequency	3200 MHz			
Number of Pins	288			
Operating Temperature	0 °C to +70 °C (+32 °F to 158 °F)			

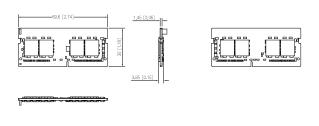
Storage Temperature	20 °C to +85 °C (-4 °F to +185 °F)	
Operating Humidity	25%–85% (non-condensing)	
Warranty	Lifetime	
Product Dimensions	69.6 mm × 30 mm × 3.58 mm (2.74" × 1.18" × 0.14")①	
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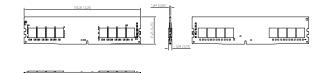
Ordering Information		
Туре	Model	Description
	DHI-DDR-C300S4G26	C300 Series DDR4 2666 4 GB Memory Module for Laptops
	DHI-DDR-C300S8G26	C300 Series DDR4 2666 8 GB Memory Module for Laptops
	DHI-DDR-C300S16G26	C300 Series DDR4 2666 16 GB Memory Module for Laptops
	DHI-DDR-C300S32G26	C300 Series DDR4 2666 32 GB Memory Module for Laptops
	DHI-DDR-C300S4G32	C300 Series DDR4 3200 4 GB Memory Module for Laptops
	DHI-DDR-C300S8G32	C300 Series DDR4 3200 8 GB Memory Module for Laptops
Portable Solid State Drive	DHI-DDR-C300S16G32	C300 Series DDR4 3200 16 GB Memory Module for Laptops
	DHI-DDR-C300S32G32	C300 Series DDR4 3200 32 GB Memory Module for Laptops
	DHI-DDR-C300U8G26	C300 Series DDR4 2666 4 GB Memory Module for Desktops
	DHI-DDR-C300U8G26	C300 Series DDR4 2666 8 GB Memory Module for Desktops
	DHI-DDR- C300U16G26	C300 Series DDR4 2666 16 GB Memory Module for Desktops
	DHI-DDR- C300U32G26	C300 Series DDR4 2666 32 GB Memory Module for Desktops
	DHI-DDR-C300U8G32	C300 Series DDR4 3200 4 GB Memory Module for Desktops

	DHI-DDR-C300U8G32	C300 Series DDR4 3200 8 GB Memory Module for Desktops
Portable Solid State Drive	DHI-DDR- C300U16G32	C300 Series DDR4 3200 16 GB Memory Module for Desktops
	DHI-DDR- C300U32G32	C300 Series DDR4 3200 32 GB Memory Module for Desktops

# Dimensions (mm[inch])







Rev 001.000

